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Understanding Embedded - FPGAs (Field Programmable Gate Array)

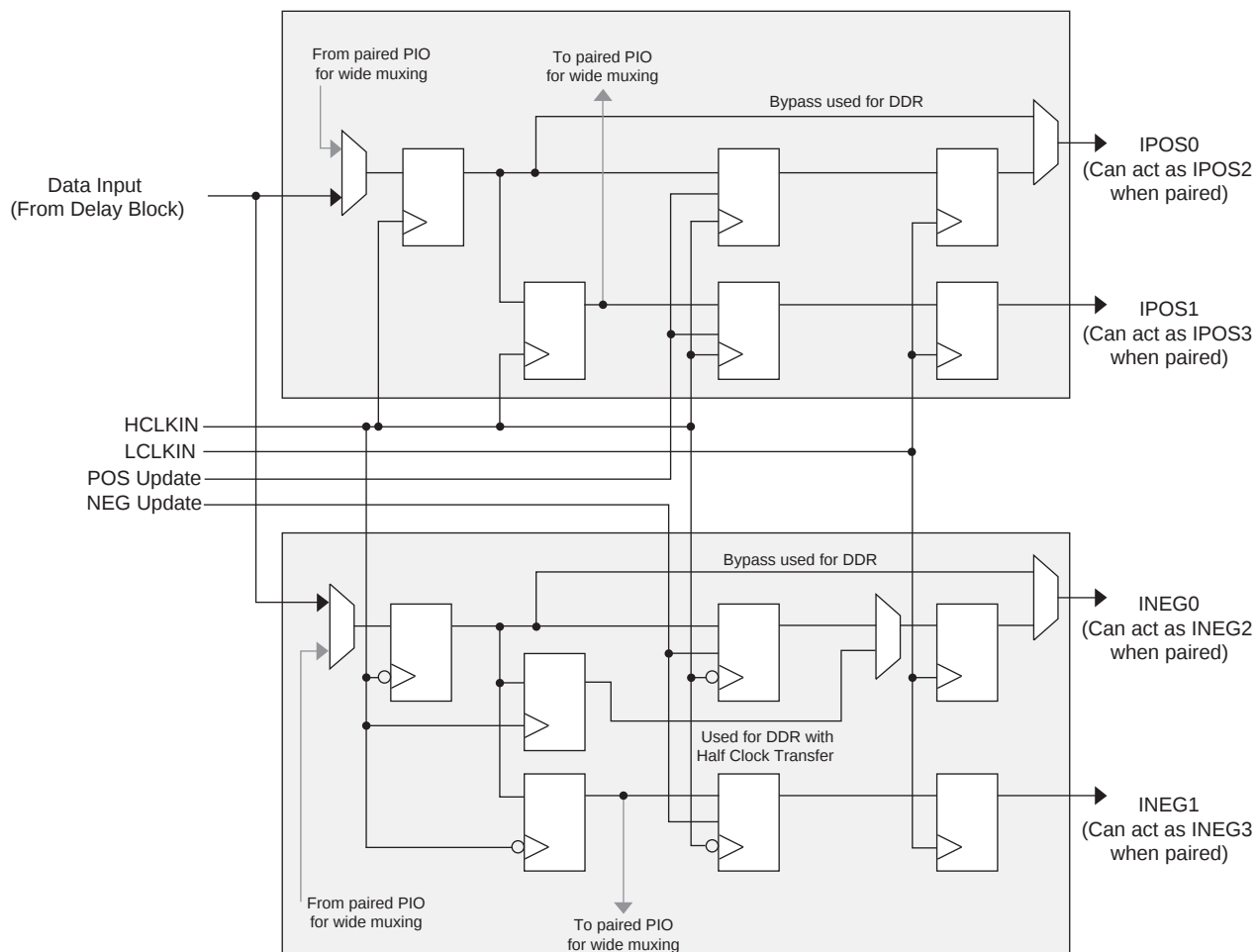
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	3750
Number of Logic Elements/Cells	15000
Total RAM Bits	1054720
Number of I/O	139
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga15e-6fn256i

Figure 2-21. Input DDR/Shift Register Block

Output Register Block

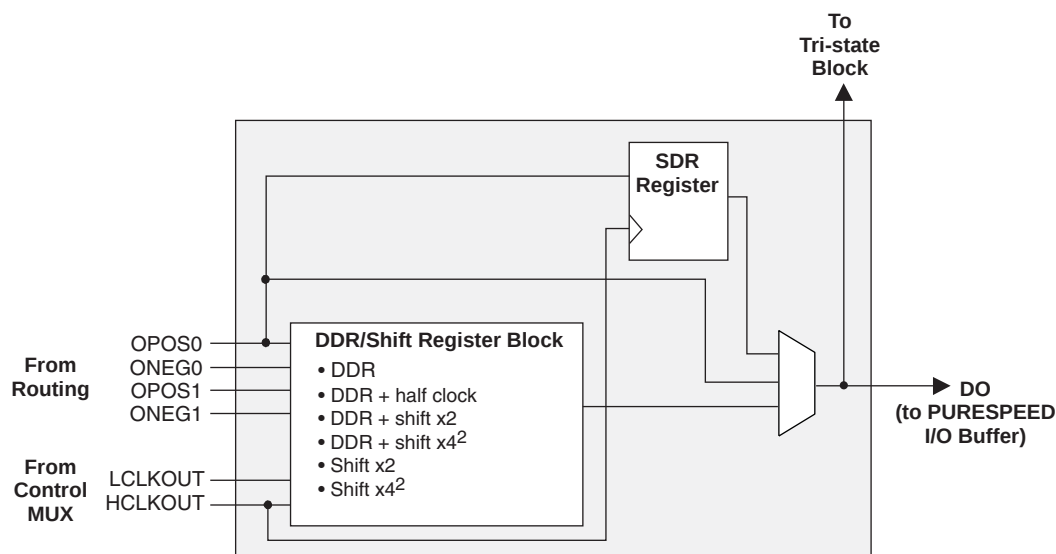
The output register block provides the ability to register signals from the core of the device before they are passed to the PURESPEED I/O buffers. The block contains a register for SDR operation and a group of registers for DDR and shift register operation. The output signal (DO) can be derived directly from one of the inputs (bypass mode), the SDR register or the DDR/shift register block. Figure 2-22 shows the diagram of the Output Register Block.

Output SDR Register/Latch Block

The SDR register operates on the positive edge of the high-speed clock. It has clock enable that is driven by the clock enable output signal generated by the control MUX. In addition it has a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR (LSR has precedence over CE) and Global Set Reset GSR enable or disable. The register LSR input is driven from LSRO, which is generated from the PIO control MUX. The GSR inputs is driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Output DDR/Shift Block

The DDR/Shift block contains registers and associated logic that support DDR and shift register functions using the high-speed clock and the associated transfer from the low-speed clock domain. It functions as a gearbox allowing low-speed parallel data from the FPGA fabric be output as a higher speed serial stream. Each PIO supports DDR and x2 shift functions. If desired PIOs A and B or C and D can be combined to form x4 shift functions. Figure 2-22 shows a simplified block diagram of the shift register block.

Figure 2-22. Output Register Block¹**Notes:**

1. CE, Update, Set and Reset not shown for clarity.
2. By four shift modes utilizes DDR/Shift register block from paired PIO.
3. DDR/Shift register block shared with tristate block.

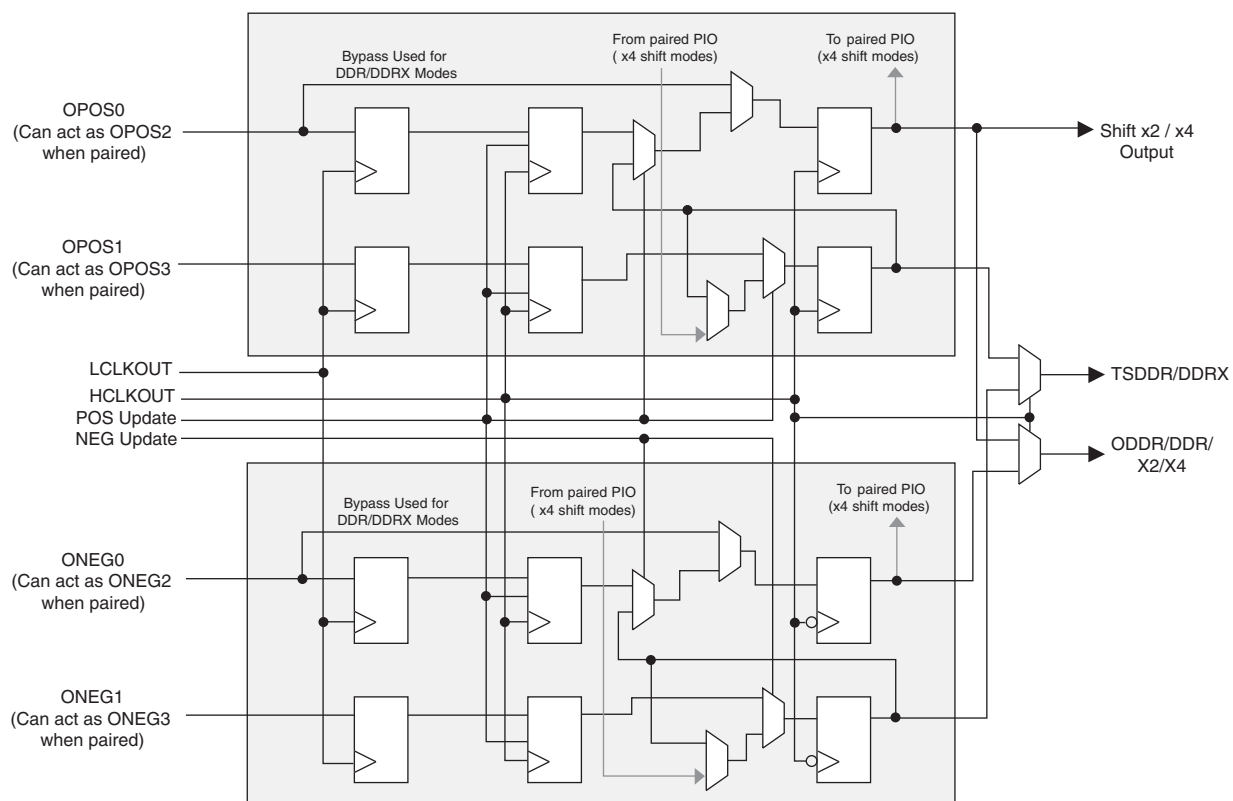
Figure 2-23. Output/Tristate DDR/Shift Register Block

Table 2-6. Input/Output/Tristate Gearing Resource Rules

PIO	Input/Output Logic			Tri-State/Bidi	
	x1	x2	x4	x1	x2/x4
A	?	?	?	?	N/A
B	?	No I/O Logic	No I/O Logic	?	N/A
C	?	?	No I/O Logic	?	N/A
D	?	No I/O Logic	No I/O Logic	?	N/A

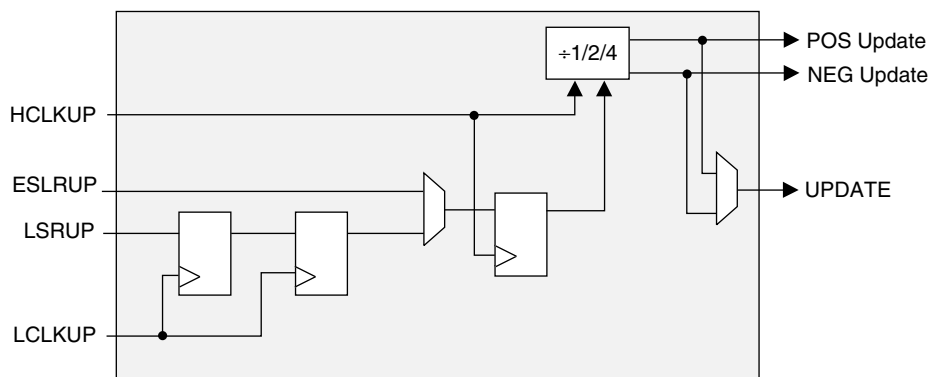
Note: Pin can still be used without I/O logic.

Control Logic Block

The control logic block allows the modification of control signals selected by the routing before they are used in the PIO. It can optionally invert all signals passing through it except the Global Set/Reset. Global Set/Reset can be enabled or disabled. It can route either the edge clock or the clock to the high-speed clock nets. The clock provided to the PIO by routing is used as the slow-speed clocks. In addition this block contains delays that can be inserted in the clock nets to enable Lattice's unique cycle boosting capability.

Update Block

The update block is used to generate the POS update and NEG update signals used by the DDR/Shift register blocks within the PIO. Note the update block is only required in shift modes. This is required in order to do the high speed to low speed handoff. One of these update signals is also selected and output from the PIC as the signal UPDATE. It consists of a shift chain that operates off either the high-speed input or output clock. The values of each register in the chain are set or reset depending on the desired mode of operation. The set/reset signal is generated from either the edge reset ELSR or the local reset LSR. These signals are optionally inverted by the Control Logic Block and provided to the update block as ELSRUP and LSRUP. The Lattice design tools automatically configure and connect the update block when one of the DDR or shift register primitives is used.

Figure 2-25. Update Block

PURESPEED I/O Buffer

Each I/O is associated with a flexible buffer referred to as PURESPEED I/O buffer. These buffers are arranged around the periphery of the device in seven groups referred to as Banks. The PURESPEED I/O buffers allow users to implement the wide variety of standards that are found in today's systems including LVCMOS, SSTL, HSTL, LVDS and LVPECL. The availability of programmable on-chip termination for both input and output use, further enhances the utility of these buffers.

PURESPEED I/O Buffer Banks

LatticeSC devices have seven PURESPEED I/O buffer banks; each is capable of supporting multiple I/O standards. Each PURESPEED I/O bank has its own I/O supply voltage (V_{CCIO}), and two voltage references V_{REF1} and V_{REF2} resources allowing each bank to be completely independent from each other. Figure 2-26 shows the seven banks and their associated supplies. Table 2-7 lists the maximum number of I/Os per bank for the whole LatticeSC family.

In the LatticeSC devices, single-ended output buffers and ratioed input buffers (LVTTTL, LVCMOS, PCI33 and PCIX33) are powered using V_{CCIO} . In addition to the bank V_{CCIO} supplies, the LatticeSC devices have a V_{CC} core logic power supply, and a V_{CCAUX} supply that power all differential and referenced buffers. V_{CCAUX} also powers a predriver of single-ended output buffers to enhance buffer performance.

Each bank can support up to two separate VREF voltages, V_{REF1} and V_{REF2} that set the threshold for the referenced input buffers. In the LatticeSC devices any I/O pin in a bank can be configured to be a dedicated reference voltage supply pin. Each I/O is individually configurable based on the bank's supply and reference voltages.

Differential drivers have user selectable internal or external bias. External bias is brought in by the V_{REF1} pin in the bank. External bias for differential buffers is needed for applications that requires tighter than standard output common mode range.

Since a bank can have only one external bias circuit for differential drivers, LVDS and RSDS differential outputs can be mixed in a bank.

If a differential driver is configured in a bank, one pin in that bank becomes a DIFFR pin. This DIFFR pin must be connected to ground via an external 1K +/-1% ohm resistor. Note that differential drivers are not supported in banks 1, 4 and 5.

In addition, there are dedicated Terminating Supply (V_{TT}) pins to be used as terminating voltage for one of the two ways to perform parallel terminations. These V_{TT} pins are available in banks 2-7, these pins are not available in some packages. When VTT termination is not required, or used to provide the common mode termination voltage (VCMT), these pins can be left unconnected on the device. If the internal or external VCMT function for differential input termination is used, the VTT pins should be unconnected and allowed to float.

There are further restrictions on the use of V_{TT} pins, for additional details refer to technical information at the end of this data sheet.

PURESPEED I/O Recommended Operating Conditions

Standard	V _{CCIO} (V)			V _{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVC MOS 33	3.135	3.3	3.465	—	—	—
LVC MOS 25	2.375	2.5	2.625	—	—	—
LVC MOS 18	1.71	1.8	1.89	—	—	—
LVC MOS 15	1.425	1.5	1.575	—	—	—
LVC MOS 12	1.14	1.2	1.26	—	—	—
LV TTL	3.135	3.3	3.465	—	—	—
PCI33	3.135	3.3	3.465	—	—	—
PCIX33	3.135	3.3	3.465	—	—	—
PCIX15	1.425	1.5	1.575	0.49V _{CCIO}	0.5V _{CCIO}	0.51V _{CCIO}
AGP1X33	3.135	3.3	3.465	—	—	—
AGP2X33	3.135	3.3	3.465	0.39V _{CCIO}	0.4V _{CCIO}	0.41V _{CCIO}
SSTL18_I, II ³	1.71	1.8	1.89	0.833	0.9	0.969
SSTL25_I, II ³	2.375	2.5	2.625	1.15	1.25	1.35
SSTL33_I, II ³	3.135	3.3	3.465	1.3	1.5	1.7
HSTL15_I, II ³	1.425	1.5	1.575	0.68	0.75	0.9
HSTL15_III ^{1,3} and IV ^{1,3}	1.425	1.5	1.575	0.68	0.9	0.9
HSTL 18_I ³ , II ³	1.71	1.8	1.89	0.816	0.9	1.08
HSTL 18_III ^{1,3} , IV ^{1,3}	1.71	1.8	1.89	0.816	1.08	1.08
GTL12 ^{1,3} , GTLPLUS15 ^{1,3}	—	—	—	0.882	1.0	1.122
LVDS	—	—	—	—	—	—
Mini-LVDS	—	—	—	—	—	—
RSDS	—	—	—	—	—	—
LVPECL33 (outputs) ²	3.135	3.3	3.465	—	—	—
LVPECL33 (inputs) ^{2,4}	—	≤ 2.5	—	—	—	—
BLVDS25 ^{2,3}	2.375	2.5	2.625	—	—	—
MLVDS25 ^{2,3}	2.375	2.5	2.625	—	—	—
SSTL18D_I ³ , II ³	1.71	1.8	1.89	—	—	—
SSTL25D_I ³ , II ³	2.375	2.5	2.625	—	—	—
SSTL33D_I ³ , II ³	3.135	3.3	3.465	—	—	—
HSTL15D_I ³ , II ³	1.425	1.5	1.575	—	—	—
HSTL18D_I ³ , II ³	1.71	1.8	1.89	—	—	—

1. Input only.

2. Inputs on chip. Outputs are implemented with the addition of external resistors.

3. Input for this standard does not depend on the value of V_{CCIO}.

4. Inputs for this standard cannot be in 3.3V VCCIO banks (≤ 2.5V only).

LatticeSC/M Internal Timing Parameters¹

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Symbol	Description	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
PFU Logic Mode Timing									
t _{LUT4_PFU}	CTOF_DEL	LUT4 delay (A to D inputs to F output)	—	0.045	—	0.050	—	0.054	ns
t _{LUT5_PFU}	MTOOFX_DEL	LUT5 delay (inputs to output)	—	0.152	—	0.172	—	0.192	ns
t _{LSR_PFU}	LSR_DEL	Set/Reset to output (asynchronous)	—	0.378	—	0.426	—	0.474	ns
t _{SUM_PFU}	M_SET	Clock to Mux (M0,M1) input setup time	0.113	—	0.131	—	0.148	—	ns
t _{HM_PFU}	M_HLD	Clock to Mux (M0,M1) input hold time	-0.041	—	-0.046	—	-0.052	—	ns
t _{SUD_PFU}	DIN_SET	Clock to D input setup time	0.072	—	0.083	—	0.094	—	ns
t _{HD_PFU}	DIN_HLD	Clock to D input hold time	-0.028	—	-0.032	—	-0.035	—	ns
t _{CK2Q_PFU}	REG_DEL	Clock to Q delay, D-type register configuration	—	0.224	—	0.252	—	0.279	ns
t _{LE2Q_PFU}	LTCH_DEL	Clock to Q delay latch configuration	—	0.294	—	0.331	—	0.367	ns
t _{LD2Q_PFU}	TLTCH_DEL	D to Q throughput delay when latch is enabled	—	0.300	—	0.338	—	0.376	ns
PFU Memory Mode Timing									
t _{CORAM_PFU}	CLKTOF_DEL	Clock to Output	—	0.575	—	0.649	—	0.724	ns
t _{SUDATA_PFU}	DIN_SET	Data Setup Time	-0.024	—	-0.026	—	-0.027	—	ns
t _{HDATA_PFU}	DIN_HLD	Data Hold Time	0.075	—	0.084	—	0.094	—	ns
t _{SUADDR_PFU}	WAD_SET	Address Setup Time	-0.176	—	-0.196	—	-0.215	—	ns
t _{HADDR_PFU}	WAD_HLD	Address Hold Time	0.110	—	0.124	—	0.138	—	ns
t _{SUWREN_PFU}	WE_SET	Write/Read Enable Setup Time	0.014	—	0.019	—	0.024	—	ns
t _{HWREN_PFU}	WE_HLD	Write/Read Enable Hold Time	0.078	—	0.086	—	0.094	—	ns
PIC Timing									
PIO Input/Output Buffer Timing									
t _{IN_PIO}	IN_DEL	Input Buffer Delay(LVCMOS25)	—	0.578	—	0.661	—	0.744	ns
t _{OUT_PIO}	DOPADI_DEL	Output Buffer Delay(LVCMOS25)	—	2.712	—	3.027	—	3.395	ns
t _{SUI_PIO}	DIN_SET	Input Register Setup Time (Data Before Clock)	0.277	—	0.312	—	0.348	—	ns
t _{HI_PIO}	DIN_HLD	Input Register Hold Time (Data after Clock)	-0.267	—	-0.306	—	-0.345	—	ns
t _{COO_PIO}	CK_DEL	Output Register Clock to Output Delay	—	0.513	—	0.571	—	0.639	ns
t _{SUCE_PIO}	CE_SET	Input Register Clock Enable Setup Time	—	0.000	—	0.000	—	0.000	ns
t _{HCE_PIO}	CE_HLD	Input Register Clock Enable Hold Time	—	0.129	—	0.145	—	0.161	ns
t _{SULSR_PIO}	LSR_SET	Set/Reset Setup Time	0.057	—	0.060	—	0.063	—	ns
t _{HLSR_PIO}	LSR_HLD	Set/Reset Hold Time	-0.151	—	-0.159	—	-0.169	—	ns
t _{LE2Q_PIO}	CK_DEL	Input Register Clock to Q delay latch configuration	—	0.335	—	0.372	—	0.410	ns
t _{LD2Q_PIO}	DIN_DEL	Input Register D to Q throughput delay when latch is enabled	—	0.578	—	0.647	—	0.717	ns

Signal Descriptions (Cont.)

Signal Name	I/O	Description
RESETN		Reset. (Also sent to general routing). During configuration it resets the configuration state machine. After configuration this pin can perform the global set/reset (GSR) functions or can be used as a general input pin.
CFGIRQN	O	MPI Interrupt request active low signal is controlled by system bus interrupt controller and may be sourced from any bus error or MPI configuration error. It can be connected to one of MPC860 IRQ pins.
TSALLN	I	Tristates all I/O.
Configuration Pads (User I/O if not used. Used during sysCONFIG.)		
HDC/SI	O	High During Configuration is output high until configuration is complete. It is used as a control output, indicating that configuration is not complete. For SPI modes, this pin is used to download the read command and initial read address into the Flash memory device on the falling edge of SCK. This pin will be connected to SI of the memory. If the SPI mode is used, the 8-bit instruction code 0x03 will be downloaded followed by a 24-bit starting address of 0x000000 or a non-zero stat address for partial reconfiguration. If the SPIX mode has been selected, the 8-bit instruction captured on D[7:0] at power-up will be shifted in and followed by a 32-bit starting address of 0x000000.
LDCN/SCS	O	Low During Configuration is output low until configuration is complete. It is used as a control output, indicating that configuration is not complete. For SPI modes, this is an active low chip select for Flash memories. It will go active after INITN goes high but before SCK begins. During power up LDCN will be low. Once INITN goes high, LDCN will go high for 100ns-200ns after which time it will go back low and configuration can begin. During the 100ns-200ns period, the read instruction will be latched for SPIX mode.
DOUT	O	Serial data output that can drive the D0/DIN of daisy-chained slave devices. The data-stream from this output will propagate preamble bits of the bitstream to daisy-chained devices. Data out on DOUT changes on the rising edge of CCLK.
QOUT/CEON	O	During daisy-chaining configuration, QOUT is the serial data output that can drive the D0/DIN of daisy-chained slave devices that do not propagate preamble bits. Data out on QOUT changes on the rising edge of CCLK. During parallel-chaining configuration, active low CEON enables the cascaded slave device to receive bitstream data.
RDN	I	Used in the asynchronous peripheral configuration mode. A low on RDN changes D[7:3] into status outputs. WRN and RDN should not be used simultaneously. If they are, the write strobe overrides.
WRN	I	When the FPGA is selected, a low on the write strobe, WRN, loads the data on D[7:0] inputs into an internal data buffer.
CS0N CS1	I	Used in the asynchronous peripheral, slave parallel and MPI modes. The FPGA is selected when CS0N is low and CS1 is high. During configuration, a pull-up is enabled on both except with MPI DMA access control.
A[21:0]	I/O	In master parallel mode, A[21:0] is an output and will address the configuration EPROMs up to 4 MB space. For MPI configuration mode, A[17:0] will be the MPI address MPL_ADDR[31:14], A[19:18] will be the transfer size and A[21:20] will be the burst mode and burst in process.

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
F19	PT37D	1	WRN/MPI_WR_N	PT46D	1	WRN/MPI_WR_N
F18	PT37C	1	D7/MPI_DATA7	PT46C	1	D7/MPI_DATA7
C18	PT37B	1	D6/MPI_DATA6	PT46B	1	D6/MPI_DATA6
C17	PT37A	1	D5/MPI_DATA5	PT46A	1	D5/MPI_DATA5
E17	PT36D	1	D4/MPI_DATA4	PT45D	1	D4/MPI_DATA4
E16	PT36C	1	D3/MPI_DATA3	PT45C	1	D3/MPI_DATA3
G18	PT35B	1	D2/MPI_DATA2	PT45B	1	D2/MPI_DATA2
G17	PT35A	1	D1/MPI_DATA1	PT45A	1	D1/MPI_DATA1
B18	PT33B	1	D0/MPI_DATA0	PT43B	1	D0/MPI_DATA0
B17	PT33A	1	QOUT/CEON	PT43A	1	QOUT/CEON
G16	PT32D	1	VREF2_1	PT42D	1	VREF2_1
A18	PT32B	1	DOUT	PT42B	1	DOUT
A17	PT32A	1	MCA_DONE_IN	PT42A	1	MCA_DONE_IN
H18	PT31B	1	MCA_CLK_P1_OUT	PT41B	1	MCA_CLK_P1_OUT
H17	PT31A	1	MCA_CLK_P1_IN	PT41A	1	MCA_CLK_P1_IN
D17	PT29B	1	MCA_CLK_P2_OUT	PT39B	1	MCA_CLK_P2_OUT
D16	PT29A	1	MCA_CLK_P2_IN	PT39A	1	MCA_CLK_P2_IN
F17	PT28D	1	MCA_DONE_OUT	PT38D	1	MCA_DONE_OUT
F16	PT28C	1	BUSYN/RCLK/SCK	PT38C	1	BUSYN/RCLK/SCK
C16	PT28B	1	DP0/MPI_PAR0	PT38B	1	DP0/MPI_PAR0
C15	PT28A	1	MPI_TA	PT38A	1	MPI_TA
B16	PT27B	1	PCLKC1_0	PT37B	1	PCLKC1_0
B15	PT27A	1	PCLKT1_0/MPI_CLK	PT37A	1	PCLKT1_0/MPI_CLK
H16	PT25D	1	DP3/PCLKC1_4/MPI_PAR3	PT35D	1	DP3/PCLKC1_4/MPI_PAR3
A16	PT25B	1	MPI_RETRY	PT35B	1	MPI_RETRY
A15	PT25A	1	A0/MPI_ADDR14	PT35A	1	A0/MPI_ADDR14
G15	PT24D	1	A1/MPI_ADDR15	PT33D	1	A1/MPI_ADDR15
F15	PT24C	1	A2/MPI_ADDR16	PT33C	1	A2/MPI_ADDR16
E15	PT24B	1	A3/MPI_ADDR17	PT33B	1	A3/MPI_ADDR17
D15	PT24A	1	A4/MPI_ADDR18	PT33A	1	A4/MPI_ADDR18
C14	PT23B	1	A5/MPI_ADDR19	PT32B	1	A5/MPI_ADDR19
C13	PT23A	1	A6/MPI_ADDR20	PT32A	1	A6/MPI_ADDR20
H14	PT21C	1	VREF1_1	PT31C	1	VREF1_1
B14	PT21B	1	A7/MPI_ADDR21	PT31B	1	A7/MPI_ADDR21
B13	PT21A	1	A8/MPI_ADDR22	PT31A	1	A8/MPI_ADDR22
G14	PT20B	1	A9/MPI_ADDR23	PT29B	1	A9/MPI_ADDR23
F14	PT20A	1	A10/MPI_ADDR24	PT29A	1	A10/MPI_ADDR24
A14	PT19B	1	A11/MPI_ADDR25	PT28B	1	A11/MPI_ADDR25
A13	PT19A	1	A12/MPI_ADDR26	PT28A	1	A12/MPI_ADDR26
G13	PT17D	1	D11/MPI_DATA11	PT27D	1	D11/MPI_DATA11
H13	PT17C	1	D12/MPI_DATA12	PT27C	1	D12/MPI_DATA12
E14	PT17B	1	A13/MPI_ADDR27	PT27B	1	A13/MPI_ADDR27
E13	PT17A	1	A14/MPI_ADDR28	PT27A	1	A14/MPI_ADDR28
G12	PT15D	1	A16/MPI_ADDR30	PT25D	1	A16/MPI_ADDR30
G11	PT15C	1	D13/MPI_DATA13	PT25C	1	D13/MPI_DATA13

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
Y6	PR42D	3	DIFFR_3	PR51D	3	DIFFR_3
W6	PR42C	3		PR51C	3	
Y2	PR42B	3		PR51B	3	
W2	PR42A	3		PR51A	3	
W7	PR40D	3		PR49D	3	
V8	PR40C	3		PR49C	3	
W4	PR40B	3		PR49B	3	
W3	PR40A	3		PR49A	3	
V5	PR39D	3		PR48D	3	
U6	PR39C	3		PR48C	3	
V3	PR39B	3		PR48B	3	
V4	PR39A	3		PR48A	3	
V10	PR38D	3		PR47D	3	
V9	PR38C	3		PR47C	3	
V2	PR38B	3		PR47B	3	
V1	PR38A	3		PR47A	3	
U8	PR36D	3		PR45D	3	
U7	PR36C	3		PR45C	3	
U2	PR36B	3		PR45B	3	
U1	PR36A	3		PR45A	3	
U5	PR35D	3		PR44D	3	
T6	PR35C	3		PR44C	3	
T1	PR35B	3		PR44B	3	
T2	PR35A	3		PR44A	3	
U9	PR34D	3		PR43D	3	
U10	PR34C	3	VREF1_3	PR43C	3	VREF1_3
R1	PR34B	3		PR43B	3	
R2	PR34A	3		PR43A	3	
T7	PR31D	3	PCLKC3_2	PR40D	3	PCLKC3_2
T8	PR31C	3	PCLKT3_2	PR40C	3	PCLKT3_2
R4	PR31B	3		PR40B	3	
R3	PR31A	3		PR40A	3	
T5	PR30D	3	PCLKC3_3	PR39D	3	PCLKC3_3
R5	PR30C	3	PCLKT3_3	PR39C	3	PCLKT3_3
P2	PR30B	3		PR39B	3	
P1	PR30A	3		PR39A	3	
T9	PR29D	3	PCLKC3_1	PR38D	3	PCLKC3_1
T10	PR29C	3	PCLKT3_1	PR38C	3	PCLKT3_1
P4	PR29B	3	PCLKC3_0	PR38B	3	PCLKC3_0
P3	PR29A	3	PCLKT3_0	PR38A	3	PCLKT3_0
P5	PR27D	2	PCLKC2_2	PR36D	2	PCLKC2_2
P6	PR27C	2	PCLKT2_2	PR36C	2	PCLKT2_2
N1	PR27B	2	PCLKC2_0	PR36B	2	PCLKC2_0
N2	PR27A	2	PCLKT2_0	PR36A	2	PCLKT2_0
R9	PR26D	2	PCLKC2_3	PR35D	2	PCLKC2_3
R8	PR26C	2	PCLKT2_3	PR35C	2	PCLKT2_3
M1	PR26B	2	PCLKC2_1	PR35B	2	PCLKC2_1
L1	PR26A	2	PCLKT2_1	PR35A	2	PCLKT2_1
N9	PR25D	2	DIFFR_2	PR23D	2	DIFFR_2
M9	PR25C	2	VREF1_2	PR23C	2	VREF1_2

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH27	PB5C	5		PB5C	5	
AH26	PB5D	5	VREF1_5	PB5D	5	VREF1_5
AN32	PB7A	5		PB7A	5	
AP32	PB7B	5		PB7B	5	
AF25	PB7C	5		PB7C	5	
AE25	PB7D	5		PB7D	5	
AN31	PB8A	5		PB9A	5	
AN30	PB8B	5		PB9B	5	
AK29	PB8C	5		PB9C	5	
AK28	PB8D	5		PB9D	5	
AP31	PB9A	5		PB11A	5	
AP30	PB9B	5		PB11B	5	
AD24	PB9C	5		PB11C	5	
AE24	PB9D	5		PB11D	5	
AM29	PB11A	5		PB13A	5	
AM28	PB11B	5		PB13B	5	
AJ27	PB11C	5		PB13C	5	
AJ26	PB11D	5		PB13D	5	
AP29	PB13A	5		PB15A	5	
AP28	PB13B	5		PB15B	5	
AK27	PB13C	5		PB15C	5	
AK26	PB13D	5		PB15D	5	
AN29	PB15A	5		PB17A	5	
AN28	PB15B	5		PB17B	5	
AG25	PB15C	5		PB17C	5	
AG24	PB15D	5		PB17D	5	
AL26	PB17A	5		PB19A	5	
AL25	PB17B	5		PB19B	5	
AG23	PB17C	5		PB19C	5	
AG22	PB17D	5		PB19D	5	
AN27	PB19A	5		PB21A	5	
AN26	PB19B	5		PB21B	5	
AF24	PB19C	5		PB21C	5	
AF23	PB19D	5		PB21D	5	
AP27	PB22A	5		PB24A	5	
AP26	PB22B	5		PB24B	5	
AK25	PB22C	5		PB24C	5	
AK24	PB22D	5		PB24D	5	
AN25	PB25A	5		PB27A	5	
AN24	PB25B	5		PB27B	5	
AE22	PB25C	5		PB27C	5	
AE21	PB25D	5		PB27D	5	
AM26	PB26A	5		PB29A	5	
AM25	PB26B	5		PB29B	5	
AF22	PB26C	5		PB29C	5	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AD5	PR94C	3	
AE2	PR94B	3	
AD2	PR94A	3	
AC5	PR92D	3	
AB5	PR92C	3	
AF1	PR92B	3	
AE1	PR92A	3	
AA11	PR91D	3	
Y11	PR91C	3	
AC4	PR91B	3	
AB4	PR91A	3	
AA8	PR90D	3	DIFFR_3
AA9	PR90C	3	
AC3	PR90B	3	
AB3	PR90A	3	
AA7	PR79D	3	
Y7	PR79C	3	
AA2	PR79B	3	
Y2	PR79A	3	
AA6	PR77D	3	
Y6	PR77C	3	
Y4	PR77B	3	
W4	PR77A	3	
W11	PR74D	3	
V11	PR74C	3	
W2	PR74B	3	
V2	PR74A	3	
W9	PR71D	3	
V9	PR71C	3	
V1	PR71B	3	
U1	PR71A	3	
W10	PR70D	3	
V10	PR70C	3	
U2	PR70B	3	
T2	PR70A	3	
Y8	PR69D	3	
W8	PR69C	3	VREF1_3
W5	PR69B	3	
V5	PR69A	3	
V7	PR66D	3	PCLKC3_2
U7	PR66C	3	PCLKT3_2
T1	PR66B	3	
R1	PR66A	3	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
W7	GND	-	
AA14	VCC	-	
AA16	VCC	-	
AA17	VCC	-	
AA18	VCC	-	
AA19	VCC	-	
AA21	VCC	-	
AB13	VCC	-	
AB22	VCC	-	
N13	VCC	-	
N22	VCC	-	
P14	VCC	-	
P16	VCC	-	
P17	VCC	-	
P18	VCC	-	
P19	VCC	-	
P21	VCC	-	
R15	VCC	-	
R17	VCC	-	
R18	VCC	-	
R20	VCC	-	
T14	VCC	-	
T16	VCC	-	
T19	VCC	-	
T21	VCC	-	
U14	VCC	-	
U15	VCC	-	
U17	VCC	-	
U18	VCC	-	
U20	VCC	-	
U21	VCC	-	
V14	VCC	-	
V15	VCC	-	
V17	VCC	-	
V18	VCC	-	
V20	VCC	-	
V21	VCC	-	
W14	VCC	-	
W16	VCC	-	
W19	VCC	-	
W21	VCC	-	
Y15	VCC	-	
Y17	VCC	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
W33	PL42C	7		PL56C	7	
Y33	PL42D	7		PL56D	7	
W37	PL43A	7		PL57A	7	
Y37	PL43B	7		PL57B	7	
Y32	PL43C	7		PL57C	7	
AA32	PL43D	7		PL57D	7	
U38	PL46A	7		PL60A	7	
V38	PL46B	7		PL60B	7	
W34	PL46C	7		PL60C	7	
Y34	PL46D	7		PL60D	7	
T40	PL47A	7	PCLKT7_1	PL61A	7	PCLKT7_1
U40	PL47B	7	PCLKC7_1	PL61B	7	PCLKC7_1
AA33	PL47C	7	PCLKT7_3	PL61C	7	PCLKT7_3
AB33	PL47D	7	PCLKC7_3	PL61D	7	PCLKC7_3
R42	PL48A	7	PCLKT7_0	PL62A	7	PCLKT7_0
T42	PL48B	7	PCLKC7_0	PL62B	7	PCLKC7_0
AA34	PL48C	7	PCLKT7_2	PL62C	7	PCLKT7_2
AB34	PL48D	7	PCLKC7_2	PL62D	7	PCLKC7_2
U41	PL50A	6	PCLKT6_0	PL64A	6	PCLKT6_0
V41	PL50B	6	PCLKC6_0	PL64B	6	PCLKC6_0
V36	PL50C	6	PCLKT6_1	PL64C	6	PCLKT6_1
W36	PL50D	6	PCLKC6_1	PL64D	6	PCLKC6_1
U42	PL51A	6		PL65A	6	
V42	PL51B	6		PL65B	6	
AB31	PL51C	6	PCLKT6_3	PL65C	6	PCLKT6_3
AC31	PL51D	6	PCLKC6_3	PL65D	6	PCLKC6_3
W38	PL52A	6		PL66A	6	
Y38	PL52B	6		PL66B	6	
AA35	PL52C	6	PCLKT6_2	PL66C	6	PCLKT6_2
AB35	PL52D	6	PCLKC6_2	PL66D	6	PCLKC6_2
W39	PL55A	6		PL69A	6	
Y39	PL55B	6		PL69B	6	
AB32	PL55C	6	VREF1_6	PL69C	6	VREF1_6
AC32	PL55D	6		PL69D	6	
W40	PL56A	6		PL70A	6	
Y40	PL56B	6		PL70B	6	
AA36	PL56C	6		PL70C	6	
AB36	PL56D	6		PL70D	6	
W41	PL57A	6		PL71A	6	
Y41	PL57B	6		PL71B	6	
AA37	PL57C	6		PL71C	6	
AB37	PL57D	6		PL71D	6	
W42	PL59A	6		PL73A	6	
Y42	PL59B	6		PL73B	6	
AC33	PL59C	6		PL73C	6	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP41	PL91B	6		PL112B	6	
AK35	PL91C	6		PL112C	6	
AL35	PL91D	6		PL112D	6	
AN38	PL93A	6		PL115A	6	
AP38	PL93B	6		PL115B	6	
AL37	PL93C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F	PL115C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F
AM37	PL93D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F	PL115D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F
AR41	PL94A	6		PL116A	6	
AT41	PL94B	6		PL116B	6	
AN37	PL94C	6		PL116C	6	
AP37	PL94D	6		PL116D	6	
AR39	PL95A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E	PL117A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E
AR40	PL95B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E	PL117B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E
AN36	PL95C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A	PL117C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A
AP36	PL95D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A	PL117D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A
AT40	XRES	-		XRES	-	
AU41	TEMP	6		TEMP	6	
AU42	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B
AV42	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B
AL33	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D
AL34	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D
AU38	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C
AV38	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C
AM34	PB4C	5		PB4C	5	
AM33	PB4D	5		PB4D	5	
AV41	PB5A	5		PB5A	5	
AW41	PB5B	5		PB5B	5	
AK30	PB5C	5		PB5C	5	
AK29	PB5D	5	VREF1_5	PB5D	5	VREF1_5
AW42	PB7A	5		PB7A	5	
AY42	PB7B	5		PB7B	5	
AR37	PB7C	5		PB7C	5	
AR38	PB7D	5		PB7D	5	
AV40	PB8A	5		PB9A	5	
AV39	PB8B	5		PB9B	5	
AN35	PB8C	5		PB9C	5	
AN34	PB8D	5		PB9D	5	
AW40	PB9A	5		PB11A	5	
AY40	PB9B	5		PB11B	5	
AP34	PB9C	5		PB11C	5	
AP35	PB9D	5		PB11D	5	
AW39	PB11A	5		PB12A	5	
AW38	PB11B	5		PB12B	5	
AL32	PB11C	5		PB12C	5	
AL31	PB11D	5		PB12D	5	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP8	PB117D	4		PB131D	4	
AY3	PB119A	4		PB133A	4	
AW3	PB119B	4		PB133B	4	
AR6	PB119C	4		PB133C	4	
AR5	PB119D	4		PB133D	4	
AU5	PB120A	4		PB134A	4	
AV5	PB120B	4		PB134B	4	
AL12	PB120C	4		PB134C	4	
AL11	PB120D	4		PB134D	4	
AV3	PB121A	4		PB135A	4	
AV4	PB121B	4		PB135B	4	
AN9	PB121C	4		PB135C	4	
AN8	PB121D	4		PB135D	4	
AW1	PB123A	4		PB138A	4	
AY1	PB123B	4		PB138B	4	
AK14	PB123C	4	VREF1_4	PB138C	4	VREF1_4
AK13	PB123D	4		PB138D	4	
AV2	PB124A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D	PB139A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
AW2	PB124B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D	PB139B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D
AM10	PB124C	4		PB139C	4	
AM9	PB124D	4		PB139D	4	
AV1	PB125A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B	PB141A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
AU1	PB125B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B	PB141B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
AL10	PB125C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C	PB141C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C
AL9	PB125D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C	PB141D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C
AT3	PROBE_VCC	-		PROBE_VCC	-	
AU2	PROBE_GND	-		PROBE_GND	-	
AP7	PR95D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A	PR117D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A
AN7	PR95C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A	PR117C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A
AR3	PR95B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E	PR117B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
AR4	PR95A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E	PR117A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
AP6	PR94D	3		PR116D	3	
AN6	PR94C	3		PR116C	3	
AT2	PR94B	3		PR116B	3	
AR2	PR94A	3		PR116A	3	
AM6	PR93D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F	PR115D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F
AL6	PR93C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F	PR115C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F
AP5	PR93B	3		PR115B	3	
AN5	PR93A	3		PR115A	3	
AL8	PR91D	3		PR112D	3	
AK8	PR91C	3		PR112C	3	
AP2	PR91B	3		PR112B	3	
AN2	PR91A	3		PR112A	3	
AJ12	PR90D	3		PR109D	3	
AH12	PR90C	3		PR109C	3	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
B22	PT61B	1	A3/MPI_ADDR17	PT69B	1	A3/MPI_ADDR17
B23	PT61A	1	A4/MPI_ADDR18	PT69A	1	A4/MPI_ADDR18
K23	PT60D	1	D25/PCLKC1_5/MPI_DATA25	PT66D	1	D25/PCLKC1_5/MPI_DATA25
J23	PT60C	1	D26/PCLKT1_5/MPI_DATA26	PT66C	1	D26/PCLKT1_5/MPI_DATA26
D22	PT60B	1	A5/MPI_ADDR19	PT66B	1	A5/MPI_ADDR19
E22	PT60A	1	A6/MPI_ADDR20	PT66A	1	A6/MPI_ADDR20
K22	PT59D	1	D27/MPI_DATA27	PT63D	1	D27/MPI_DATA27
J22	PT59C	1	VREF1_1	PT63C	1	VREF1_1
D23	PT59B	1	A7/MPI_ADDR21	PT63B	1	A7/MPI_ADDR21
C23	PT59A	1	A8/MPI_ADDR22	PT63A	1	A8/MPI_ADDR22
L23	PT57D	1	D28/PCLKC1_6/MPI_DATA28	PT61D	1	D28/PCLKC1_6/MPI_DATA28
M23	PT57C	1	D29/PCLKT1_6/MPI_DATA29	PT61C	1	D29/PCLKT1_6/MPI_DATA29
A24	PT57B	1	A9/MPI_ADDR23	PT61B	1	A9/MPI_ADDR23
B24	PT57A	1	A10/MPI_ADDR24	PT61A	1	A10/MPI_ADDR24
K25	PT56D	1	D30/PCLKC1_7/MPI_DATA30	PT58D	1	D30/PCLKC1_7/MPI_DATA30
J25	PT56C	1	D31/PCLKT1_7/MPI_DATA31	PT58C	1	D31/PCLKT1_7/MPI_DATA31
F23	PT56B	1	A11/MPI_ADDR25	PT58B	1	A11/MPI_ADDR25
F22	PT56A	1	A12/MPI_ADDR26	PT58A	1	A12/MPI_ADDR26
J26	PT55D	1	D11/MPI_DATA11	PT57D	1	D11/MPI_DATA11
K26	PT55C	1	D12/MPI_DATA12	PT57C	1	D12/MPI_DATA12
E23	PT55B	1	A13/MPI_ADDR27	PT57B	1	A13/MPI_ADDR27
E24	PT55A	1	A14/MPI_ADDR28	PT57A	1	A14/MPI_ADDR28
G23	PT53D	1	A16/MPI_ADDR30	PT55D	1	A16/MPI_ADDR30
G24	PT53C	1	D13/MPI_DATA13	PT55C	1	D13/MPI_DATA13
F26	PT53B	1	A15/MPI_ADDR29	PT55B	1	A15/MPI_ADDR29
F27	PT53A	1	A17/MPI_ADDR31	PT55A	1	A17/MPI_ADDR31
H25	PT52D	1	A19/MPI_TSI21	PT54D	1	A19/MPI_TSI21
H24	PT52C	1	A20/MPI_BDIP	PT54C	1	A20/MPI_BDIP
C25	PT52B	1	A18/MPI_TSI20	PT54B	1	A18/MPI_TSI20
C26	PT52A	1	MPI_TEA	PT54A	1	MPI_TEA
K24	PT51D	1	D14/MPI_DATA14	PT51D	1	D14/MPI_DATA14
J24	PT51C	1	DP1/MPI_PAR1	PT51C	1	DP1/MPI_PAR1
F24	PT51B	1	A21/MPI_BURST	PT51B	1	A21/MPI_BURST
F25	PT51A	1	D15/MPI_DATA15	PT51A	1	D15/MPI_DATA15
L26	D_REFCLKP_L	-		D_REFCLKP_L	-	
M26	D_REFCLKN_L	-		D_REFCLKN_L	-	
G27	VCC12	-		VCC12	-	
C29	D_VDDIB3_L	-		D_VDDIB3_L	-	
F28	VCC12	-		VCC12	-	
D26	D_HDINP3_L	-	PCS 363 CH 3 IN P	D_HDINP3_L	-	PCS 363 CH 3 IN P
E26	D_HDINN3_L	-	PCS 363 CH 3 IN N	D_HDINN3_L	-	PCS 363 CH 3 IN N
B25	D_HDOUTP3_L	-	PCS 363 CH 3 OUT P	D_HDOUTP3_L	-	PCS 363 CH 3 OUT P
D24	VCC12	-		VCC12	-	
A25	D_HDOUTN3_L	-	PCS 363 CH 3 OUT N	D_HDOUTN3_L	-	PCS 363 CH 3 OUT N
E25	D_VDDOB3_L	-		D_VDDOB3_L	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
L8	VCCIO2	-		VCCIO2	-	
M3	VCCIO2	-		VCCIO2	-	
P7	VCCIO2	-		VCCIO2	-	
R4	VCCIO2	-		VCCIO2	-	
T12	VCCIO2	-		VCCIO2	-	
U8	VCCIO2	-		VCCIO2	-	
V3	VCCIO2	-		VCCIO2	-	
W11	VCCIO2	-		VCCIO2	-	
Y7	VCCIO2	-		VCCIO2	-	
AB3	VCCIO3	-		VCCIO3	-	
AC7	VCCIO3	-		VCCIO3	-	
AD11	VCCIO3	-		VCCIO3	-	
AE4	VCCIO3	-		VCCIO3	-	
AF8	VCCIO3	-		VCCIO3	-	
AG12	VCCIO3	-		VCCIO3	-	
AH3	VCCIO3	-		VCCIO3	-	
AJ7	VCCIO3	-		VCCIO3	-	
AK11	VCCIO3	-		VCCIO3	-	
AL4	VCCIO3	-		VCCIO3	-	
AM8	VCCIO3	-		VCCIO3	-	
AP3	VCCIO3	-		VCCIO3	-	
AR7	VCCIO3	-		VCCIO3	-	
AU4	VCCIO3	-		VCCIO3	-	
AL16	VCCIO4	-		VCCIO4	-	
AM13	VCCIO4	-		VCCIO4	-	
AM19	VCCIO4	-		VCCIO4	-	
AR11	VCCIO4	-		VCCIO4	-	
AR17	VCCIO4	-		VCCIO4	-	
AT14	VCCIO4	-		VCCIO4	-	
AT20	VCCIO4	-		VCCIO4	-	
AT8	VCCIO4	-		VCCIO4	-	
AW15	VCCIO4	-		VCCIO4	-	
AW21	VCCIO4	-		VCCIO4	-	
AW9	VCCIO4	-		VCCIO4	-	
AY12	VCCIO4	-		VCCIO4	-	
AY18	VCCIO4	-		VCCIO4	-	
AY6	VCCIO4	-		VCCIO4	-	
AL27	VCCIO5	-		VCCIO5	-	
AM24	VCCIO5	-		VCCIO5	-	
AM30	VCCIO5	-		VCCIO5	-	
AR26	VCCIO5	-		VCCIO5	-	
AR32	VCCIO5	-		VCCIO5	-	
AT23	VCCIO5	-		VCCIO5	-	
AT29	VCCIO5	-		VCCIO5	-	
AT35	VCCIO5	-		VCCIO5	-	

Date	Version	Section	Change Summary
February 2006	01.0	—	Initial release.
March 2006	01.1	Introduction	SC25 1020 I/O count changed to 476.
		Architecture	Changed ROM 16X4 to ROM 16X2.
			Changed “X2 or X4” to “DIV2 or DIV4”.
			Added Global Set/Reset Section.
		DC and Switching Characteristics	Added notes 5 and 6 to Recommended Operating Conditions table.
			Added Power Supply Ramp Rates table.
			Removed -5 and -6 speed grades from Typical Building Block Performance table.
			Added Input Delay Timing table.
			Added Synchronous GSR Timing table.
		Pinout Information	Expanded PROBE_VCC and PROBE_GND description.
			Removed A-RXREFCLKP_[L/R] from Signal Description table.
			Added RESP_[ULC/URC] to Signal Description table.
			Added notes 1 and 2 to Signal Description table.
			Changed number of NCs to 28.
			Changed number of SERDES (signal + power supply) to 74.
			Removed RESP balls from NC list (B2, C2, B29, C29).
			Added note to VTT table.
			Changed RxRefclk (B2 and C2) to NC.
			Added RESP_ULC.
			Added RESP_URC.
			Changed RxRefclk (B29 and C29) to NC.
June 2006	01.2	Introduction	Changed SERDES min bandwidth from 622 Mbps to 600 Mbps.
			Changed max SERDES bandwidth from 3.4 Gbps to 3.8 Gbps.
			Corrected number of package I/Os for the SC80 and SC115 1704 pin packages.
			Updated speed performance for typical functions with ispLEVER 6.0 values.
		Architecture	Changed “When these pins are not used they should be left unconnected.” with “Unused VTT pins should be connected to GND if the internal or external VCMT function is not used in the bank. If the internal or external VCMT function for differential input termination is used, the VTT pins should be unconnected and allowed to float.”
			Added “SERDES Power Supply Sequencing Requirements” section.
			Changed total bandwidth per quad from 13.6 Gbps to 15.2 Gbps.
			Added the accuracy of the temperature-sensing diode to be typically +/- 10 °C. Also referred to a temperature-sensing diode application note for more information.
		DC and Switching Characteristics	Changed “CTAP” to “internal or external VCMT”.
			Changed VCC12 parameter to include VDDP, VDDTX and VDDRFX.
			Changed typical values to match ispLEVER 6.0 Power Calculator.

Date	Version	Section	Change Summary
August 2006 (cont.)	01.3 (cont.)	DC and Switching Characteristics (cont.)	Updated LatticeSC Family Timing Adders with ispLEVER 6.0 SP1 results
			Updated PLL Timing Parameters based on PDE testing results
			Removed RDDATA parameter from sysCONFIG readback timing table
		Multiple	Changed TDO/RDDATA to TDO
		Pinout Information	Removed all MPI signals from SC15 256 pin package Dual Function Column
			Added note to SC15, SC25 900 pin package that the package supports a 16 bit MPI
			Added note that pin D3 in an SC15 and SC25 900 pin package should not be used for single-ended outputs
			Added note that pin D28 in an SC15 and SC25 900 pin package should not be used for single-ended outputs
			Added note to SC25 1020 pin package that the package supports a 16 bit MPI
			Added note to SC80 1152 pin package that the package supports a 32 bit MPI
			Added note to SC80 1704 pin package that the package supports a 32 bit MPI
		Ordering Information	Changed "fcBGA" for the 1020 packages to "ffBGA"
November 2006	01.4	Introduction	LatticeSC Family Selection Guide table – I/O count for SC80 device, 1704 fcBGA package changed to 904/32. I/O count for SC115 device, 1704 fcBGA package changed to 942/32.
		DC and Switching Characteristics	DC Electrical Characteristics table – Updated the initialization and standby supply current values.
			DC Electrical Characteristics table – Updated the sysCONFIG Master Parallel mode RCLK low and RCLK high time specifications.
			DC Electrical Characteristics table – Updated VCCIO values for LVPECL33 I/Os.
		Pin Information	Pin Information Summary table - Changed number of single ended user I/Os from 906 to 904 for 1704 fcBGA.
			Removed the single-ended only output restriction on pins D3 and D28 in an SC15 and SC25 900 pin package.
		Ordering Information	Ordering Information tables - Changed number of I/Os from 906 to 904 for 1704 fcBGA.
			Added ordering part numbers for LatticeSC/SCM 40K and 115K LUT devices.
			Added lead-free ordering part numbers.
		Multiple	Changed number of available SC80 I/O from 906 to 904. Changed number of available SC115 I/O from 944 to 942.
January 2007	01.4a	Architecture	Added EBR Asynchronous Reset section.
February 2007	01.4b	Architecture	Updated EBR Asynchronous Reset section.
March 2007	01.5	Architecture	Added EBR asynchronous reset clarification
			Clarified that differential drivers are not supported in banks 1, 4 and 5
		DC and Switching Characteristics	Added clarification for the description of the junction temperature specification in the Absolute Maximum Ratings section.
			Updated Initialization and Standby Current table. Updated LatticeSC External Switching Characteristics with ispLEVER 6.1 SP1 results.

Date	Version	Section	Change Summary
March 2007 (cont.)	01.5 (cont.)	DC and Switching Characteristics (cont.)	Updated LatticeSC Internal Timing Parameters with ispLEVER 6.1 SP1 results.
			Updated t_{FDEL} and t_{CDEL} specifications.
			Updated LatticeSC Family Timing Adders with ispLEVER 6.1 SP1 results.
			Updated PLL specifications to expand frequency range down to 2 MHz and break out jitter for the different ranges.
			Added footnote to sysCLOCK PLL Timing table specifying the conditions for the jitter measurements.
			Added t_{DLL} specification to sysCLOCK DLL Timing table.
			Added footnote to sysCLOCK DLL Timing table specifying the conditions for the jitter measurements.
			Added sysCONFIG Master Parallel Configuration Mode and sysCONFIG SPI Port to LatticeSC sysCONFIG Port Timing table.
		Pin Information	Updated Pin Information Summary with SC40 information.
			Updated LFSC25 Logic Signal Connections: FF1020 with SC40 information.
			Updated LFSC80 Logic Signal Connections: FC1152 with SC40 information.
August 2007	01.6	General	Changed references of "HDC" to "HDC/SI".
			Changed references of "LDCN" to "LDCN/SCS".
			Changed references of "BUSYN/RCLK" to "BUSYN/RCLK/SCK".
			Changed references of "RDCFGN" to "TSALLN".
			Changed references of "TDO/RDDATA" to "TDO".
		Architecture	Updated text in Ripple Mode section.
			Added information to Global Set/Reset.
			Added information for Spread Spectrum Clocking
			Modified information for PLL/DLL Cascading. DLL to PLL is now supported.
			Modified AIL Block text and figure.
			Modified Figure 2-20 DDR/Shift Register Block.
			Added Information to Hot Socketing.
			Added new information for I/O Architecture Rules.
			Added information to SERDES Power Supply Sequencing Requirements.
		DC and Switching Characteristics	Added footnote to Hot Socketing Specifications table.
			Modified Initialization and Standby Supply Current table.
			Modified GSR Timing table.
			Modified sysCLOCK DLL Timing table to include I_{DUTY} .
			Deleted Readback Timing information from sysCONFIG Port Timing table.
			Modified data in External Switching Characteristics table.
		Pin Information	Added information to the Signal Descriptions table for HDC/SI, LDCN/SCS.
			Added footnote to Signal Descriptions table.
			Modified Description for signal BUSYN/RCLK/SCK.
			Modified data in Pin Information Summary and device-specific Pinout Information tables.